



RECOMMEND PCB LAYOUT
(TOLERANCE=±0.05)

1. MATERIAL
 - 1.1 INSULATOR: THERMOPLASTIC (UL 94V-0).
 - 1.2 CONTACT MATERIAL: COPPER ALLOY.
2. SPECIFICATION
 - 2.1 CURRENT RATING: 1.5 Amp.
 - 2.2 INSULATION RESISTANCE: 1000mΩ Min.
 - 2.3 DIELECTRIC WITHSTANDING: 600VAC.
 - 2.4 CONTACT RESISTENCE: 20mΩ Max.
 - 2.5 OPERATING TEMPERATURE: -40°C TO +105°C.
3. PLASTIC WITHSTAND TEMP
 - 3.1 MAX PROCESSING TEMP:
 - 180°C FOR 30-60 SEC; (200°C FOR 5-10 SEC.) - PBT
 - 230°C FOR 30-60 SEC; (260°C FOR 5-10 SEC.) - PA6T

PH 200 - XXX - XXX GX

Gender	Plating
P=Pin Header	Standard: G0
F=Female Header	G0: Gold
	Flash G2: 1U"
	Gold G3: 3U"
	Gold G4: 5U"
	Gold G5: 10U" Gold
	G6: 15U" Gold
	Gold SN: Tin
Pitch	Packing Style
0.80=080	1. Loose in Bag
1.00=100	2. Tape & Reel
1.27=127	3. Tube
2.00=200	
2.54=254	
No. of PINS	Insulator Material
1 x 01 ~ 1 x 40 PINS	1: PBT
2 x 01 ~ 2 x 40 PINS	2: PA6T
3 x 01 ~ 3 x 40 PINS	3: PA9T
	4: LCP
Connector Type	
S= Straight	
R= Right Angle	
M= SMT	

PRODUCT TITLE:	2.00mm Elevated Pin Header, Right Angle, Dual Row		
UNLESS OTHERWISE SPECIFIED TOLERANCES	SCALE: 1/1	UNIT: mm	⊕ ⊖ PH200-2XX-RXXG0-13
	SIZE: A3	PAGE: 1 OF 1	RAV.A01
DECIMALS:	ANGLES:	WAYCONN ELECTRONICS	
X : ±0.5	X : ±6°		
X.X : ±0.3	X.X : ±3°		
X.XX : ±0.2	X.XX : ±2°		